

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application)	<u>PATENT APPLICATION</u>
)	
Inventors:)	
Dean B. Jacobs and)	
Eric M. Halpern)	
)	
SC/Serial No.:)	
Unknown)	
)	
Filed:)	
Herewith)	
)	
Title: A DUPLICATED NAMING SERVICE IN A)	
DISTRIBUTED PROCESSING SYSTEM)	

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if one name is listed below), first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**A DUPLICATED NAMING SERVICE IN A DISTRIBUTED
PROCESSING SYSTEM**

the specification of which (check applicable ones):

 X is filed herewith;

 was filed with the above-identified "Filed" date and "SC/Serial No."

 was amended on (or amended through) ____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of the application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

(1) Full name of sole
or first inventor: Dean B. Jacobs

(1) Residence: 1747 Madera Street
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(1) Post Office Address: Same

(1) Citizenship: U.S.A.

(1) Inventor's signature: Dean Jacobs

(1) Date: 9/23/99

(2) Full name of second
joint inventor: Eric M. Halpern

(2) Residence: 41 Delmar Street
San Francisco, California 94117

(2) Post Office Address: Same

(2) Citizenship: U.S.A.

(2) Inventor's signature: Eric M. Halpern

(2) Date: 9/23/99